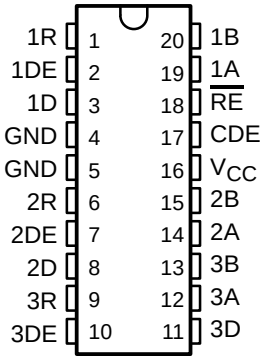
SLLS117B – APRIL 1991 – REVISED MAY 1995

- **Three Bidirectional Transceivers**
- **Driver/Receiver Meets or Exceeds the Requirements of ANSI Standard RS-485 and ANSI Standard X3.131-1986 (SCSI)**
- **High-Speed Advanced Low-Power Schottky Circuitry**
- **Designed for Multipoint Transmission on Long Bus Lines in Noisy Environments**
- **Wide Positive and Negative Input/Output Bus Voltages Ranges . . . –7 V to 12 V**
- **Driver Output Capacity . . . ±60 mA**
- **Driver Positive and Negative Current Limiting**
- **Thermal Shutdown Protection**
- **Receiver Input Sensitivity . . . ±200 mV Max**
- **Receiver Input Impedance . . . 12 kΩ Min**
- **Receiver Input Hysteresis . . . 50 mV Typ**
- **Operates From a Single 5-V Supply**
- **Low Supply-Current Requirements 72 mA Max**
- **Glitch-Free Power-up and Power-Down Protection**

DW OR N PACKAGE
(TOP VIEW)



Function Tables

EACH DRIVER

INPUT	ENABLES		OUTPUTS	
D	DE	CDE	A	B
H	H	H	H	L
L	H	H	L	H
X	L	X	Z	Z
X	X	L	Z	Z

EACH RECEIVER

DIFFERENTIAL INPUTS A – B	ENABLE $\overline{RE}$	OUTPUT R
$V_{ID} \geq 0.2$ V	L	H
$V_{ID} = -0.2$ V to 0.2 V	L	?
$V_{ID} \leq -0.2$ V	L	L
X	H	Z
Open	L	H

H = high level, L = low-level, ? = indeterminate,
X = irrelevant, Z = high impedance (off)

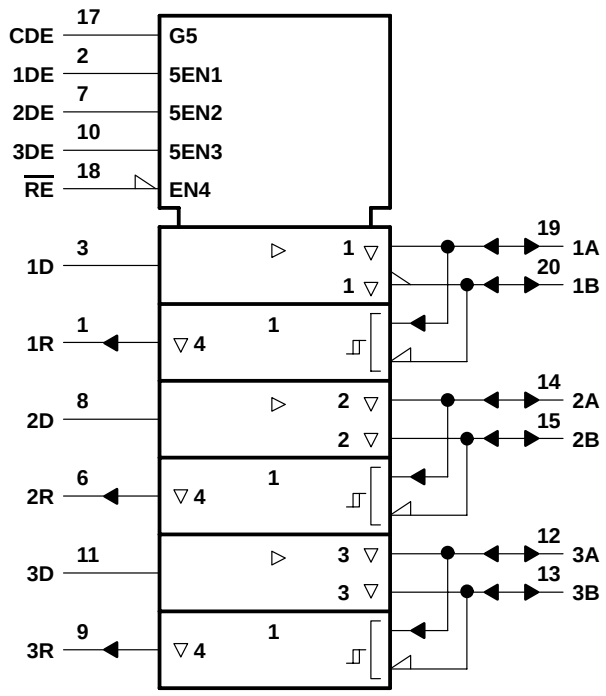
description

The SN75ALS1711 triple differential bus transceiver is a monolithic integrated circuit designed for bidirectional data communication on multipoint bus transmission lines. It is designed for balanced transmission lines and meets ANSI Standard RS-485 and ANSI Standard X3.131-1986 (SCSI).

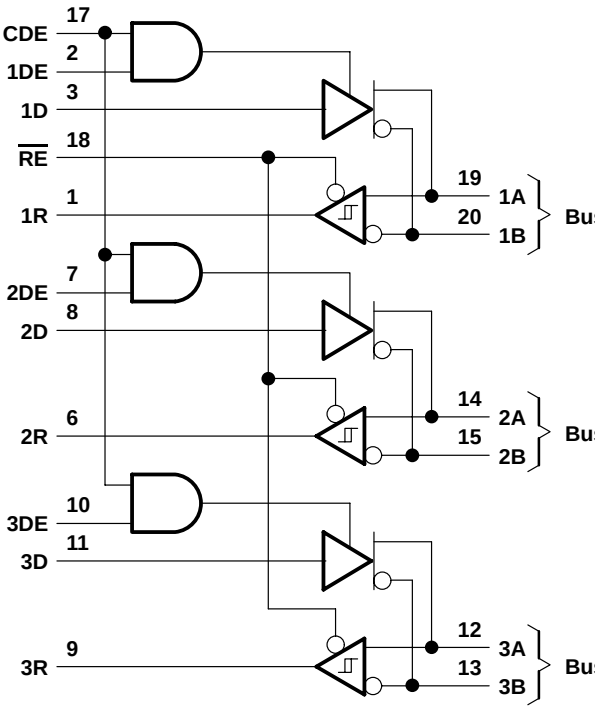
The SN75ALS1711 operates from a single 5-V power supply. The drivers and receivers have individual active-high and active-low enables, respectively, which can be externally connected together to function as a direction control. The driver differential output and the receiver differential input pairs are connected internally to form differential input/output (I/O) bus ports that are designed to offer minimum loading to the bus when the driver is disabled or V_{CC} is at 0. These ports feature wide positive and negative common-mode voltage ranges making the device suitable for party-line applications.

The SN75ALS1711 is characterized for operation from 0°C to 70°C.

logic symbol†

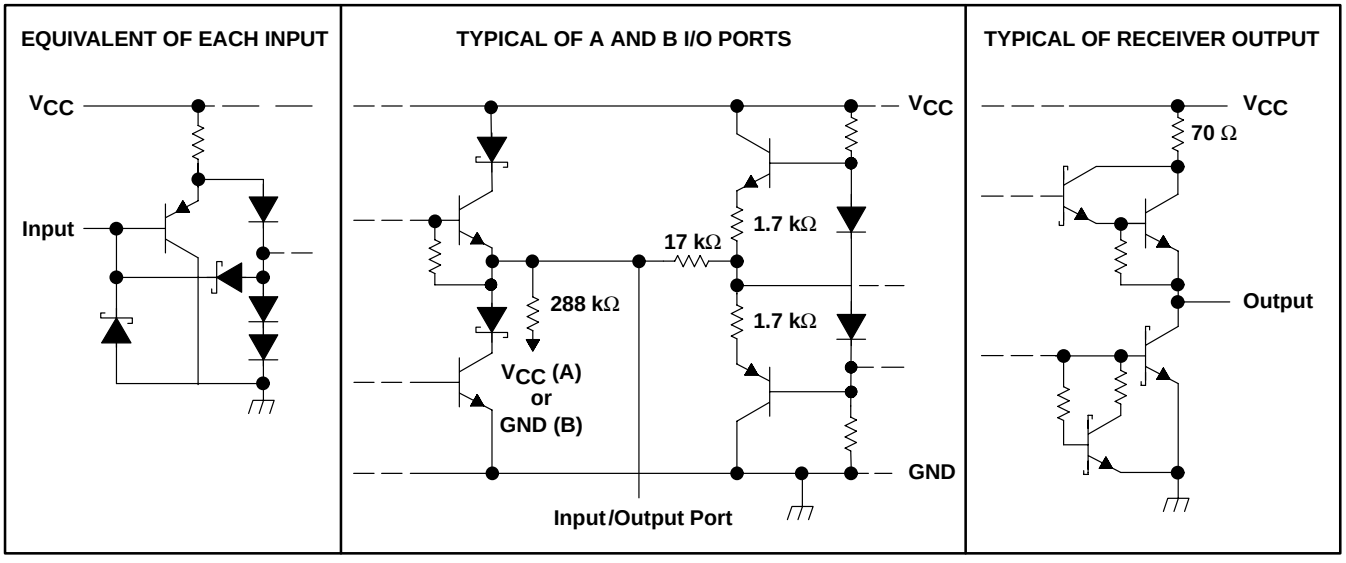


logic diagram (positive logic)



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

schematics of inputs and outputs



All values are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC} (see Note 1) . . . . . –0.5 V to 7 V
Enable input voltage range, V_I . . . . . –0.5 V to V_{CC} + 0.5 V
Input voltage range, V_I: Driver . . . . . –0.5 V to V_{CC} + 0.5 V
Receiver . . . . . –9 V to 14 V
Output voltage range, V_O: Driver . . . . . –9 V to 14 V
Receiver . . . . . –0.5 V to V_{CC} + 0.5 V
Continuous total power dissipation . . . . . See Dissipation Rating Table
Operating free-air temperature range, T_A . . . . . 0°C to 70°C
Storage temperature range, T_{stg} . . . . . –65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds . . . . . 260°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values, except differential input/output bus voltage, are with respect to network ground terminal.

DISSIPATION RATING TABLE

PACKAGE	$T_A \le 25°C$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25°C$	$T_A = 70°C$ POWER RATING
DW	1125 mW	9.0 mW/°C	720 mW
N	1150 mW	9.2 mW/°C	736 mW

recommended operating conditions

		MIN	TYP	MAX	UNIT
Supply voltage, V_{CC}		4.75	5	5.25	V
Common-mode input voltage at any bus terminal, V_{IC} (see Note 2)		–7‡		12	V
High-level input voltage, V_{IH}	D, DE, $\overline{RE}$, CDE	2			V
Low-level input voltage, V_{IL}	D, DE, $\overline{RE}$, CDE			0.8	V
High-level output current, I_{OH}	Driver			–60	mA
	Receiver			–400	µA
Low-level output current, I_{OL}	Driver			60	mA
	Receiver			8	
Operating free-air temperature, T_A		0		70	°C

‡ The algebraic convention, in which the less-positive (more-negative) limit is designated minimum, is used in this data sheet for common-mode input voltage and threshold voltage levels only.

NOTE 2: Differential-input/output bus voltage is measured at the noninverting terminal A with respect to the inverting terminal B.

DRIVER SECTION

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP†	MAX	UNIT
V_{IK}	Input clamp voltage	I_I = –18 mA				–1.5	V
V_O	Output voltage	I_O = 0		0		6	V
V_{OD1}	Differential output voltage	I_O = 0		1.5		5	V
V_{OD2}	Differential output voltage	R_L = 54 Ω, See Figure 1		1.5		5	V
V_{OD3}	Differential output voltage	See Note 3 and Figure 2		1.5		5	V
$\Delta\lvert V_{OD}\rvert$	Change in magnitude of differential output voltage‡	R_L = 54 Ω, See Figure 1				±0.2	V
V_{OC}	Common-mode output voltage	R_L = 54 Ω, See Figure 1				3 –1	V
$\Delta\lvert V_{OC}\rvert$	Change in magnitude of common-mode output voltage‡	R_L = 54 Ω, See Figure 1				±0.2	V
I_{OZ}	High-impedance state output current	Output disabled, V_{CC} = 5.25 V	V_O = 12 V			1	mA
			V_O = 7 V			–0.8	
I_{IH}	High-level input current, DE, EN, CDE	V_{IH} = 2.4 V				20	µA
I_{IL}	Low-level input current, DE, EN, CDE	V_{IL} = 0.4 V				–200	µA
I_{OS}	Short-circuit output current	V_O = 12 V				–250	mA
		V_O = 7 V				250	
I_{CC}	Supply current	No load	Outputs enabled		48	72	mA
			Outputs disabled		30	48	

† All typical values are at V_{CC} = 5 V and T_A = 25°C.
‡ $\Delta|V_{OD}|$ and $\Delta|V_{OC}|$ are the changes in magnitude of V_{OD} and V_{OC}, respectively, that occur when the input is changed from a high level to a low level.
NOTE 3: This applies for both power on and off; refer to ANSI Standard RS-485 for exact conditions.

switching characteristics, V_{CC} = 5 V ± 5%, T_A = 25°C

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
t_{PLH}	Differential propagation delay time, low- to high-level output	R_L = 54 Ω, C_L = 100 pF, See Figure 3		8	13	22	ns
t_{PHL}	Differential propagation delay time, high- to low-level output			8	15	22	
t_{PZH}	Output enable time to high level	R_L = 110 Ω, See Figure 4	S1 open, S2 closed	30	50	60	ns
t_{PHZ}	Output disable time from high level			4	16	30	
t_{PZL}	Output enable time to low level		S1 closed, S2 open	16	26	45	
t_{PLZ}	Output disable time from low level			4	8	20	

RECEIVER SECTION

electrical characteristics over recommended ranges of common-mode input voltage, supply voltage, and operating free-air temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP†	MAX	UNIT
V_{IT+}	Positive-going input threshold voltage	V_O = 2.7 V, I_O = –0.4 mA				0.2	V
V_{IT-}	Negative-going input threshold voltage	V_O = 0.5 V, I_O = 4 mA		–0.2‡			V
V_{hys}	Hysteresis voltage ($V_{IT+} - V_{IT-}$)				50		mV
V_{IK}	Input clamp voltage, $\overline{RE}$	I_I = 18 mA				–1.5	V
V_{OH}	High-level output voltage	I_{OH} = –0.4 mA		2.4			V
V_{OL}	Low-level output voltage	I_{OL} = 4 mA				0.5	V
I_{OZ}	High-impedance-state output current	V_{CC} = 5.25 V,	V_O = 0.4 V to 2.4 V			±20	μA
I_I	Line input current	Other input at 0, See Note 3	V_I = 12 V			1	mA
			V_I = 7 V			–0.8	
I_{IH}	High-level input current, $\overline{RE}$	V_{IH} = 2.4 V				20	μA
I_{IL}	Low-level input current, $\overline{RE}$	V_{IL} = 0.4 V				–200	μA
r_i	Input resistance			12			kΩ
I_{OS}	Short-circuit output current§	V_O = 0		–15		–130	mA
I_{CC}	Supply current	No load	Outputs enabled		48	72	mA
			Outputs disabled		30	48	

† All typical values are at V_{CC} = 5 V and T_A = 25°C.
‡ The algebraic convention, in which the less-positive (more-negative) limit is designated minimum, is used in this data sheet for common-mode input voltage and threshold voltage levels only.
§ Not more than one output should be shorted at one time.
NOTE 3: This applies for both power on and off; refer to ANSI Standard RS-485 for exact conditions.

switching characteristics, V_{CC} = 5 V ± 5%, T_A = 25°C

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
t_{PLH}	Propagation delay time, low- to high-level output	See Figures 5 and 6		13	20	37	ns
t_{PHL}	Propagation delay time, high- to low-level output			13	20	37	
t_{PZH}	Output enable time to high level	See Figures 5 and 7	S1 to 1.5 V, S2 open, S3 closed	3	9	20	ns
t_{PHZ}	Output disable time from high level			8	15	22	
t_{PZL}	Output enable time to low level		S1 to –1.5 V, S2 closed, S3 open	5	10	20	
t_{PZL}	Output enable time to low level			5	9	16	

PARAMETER MEASUREMENT INFORMATION

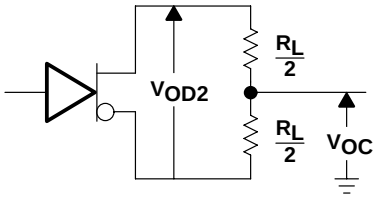


Figure 1. Driver V_{OD} and V_{OC}

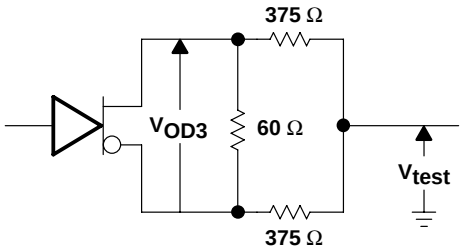
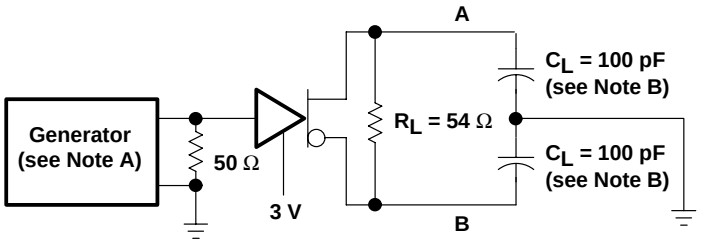


Figure 2. Driver V_{OD3}



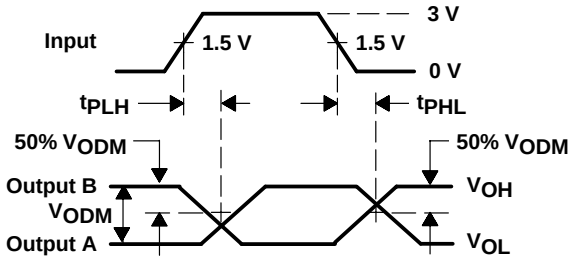
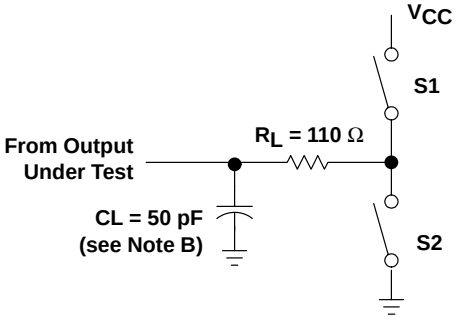
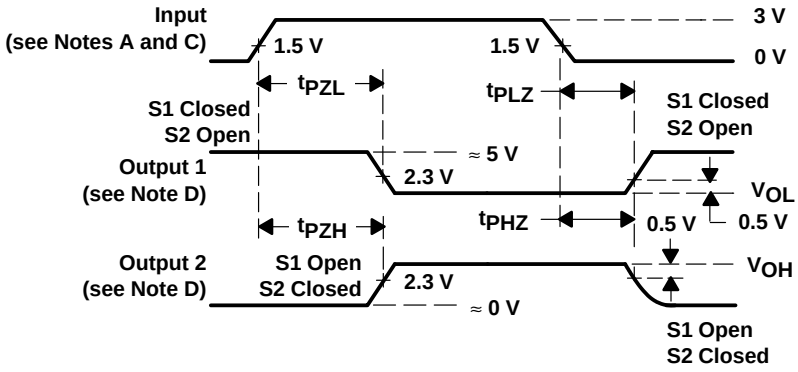


Figure 3. Driver Propagation Delay Times





NOTES: A. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, Z_O = 50 Ω, t_r ≤ 10 ns, t_f ≤ 10 ns.
B. C_L includes probe and jig capacitance.
C. Each enable is tested separately.
D. Output 1 and output 2 are outputs with internal conditions such that the output is low or high except when disabled by the output control.

Figure 4. Driver Enable/Disable Times

PARAMETER MEASUREMENT INFORMATION

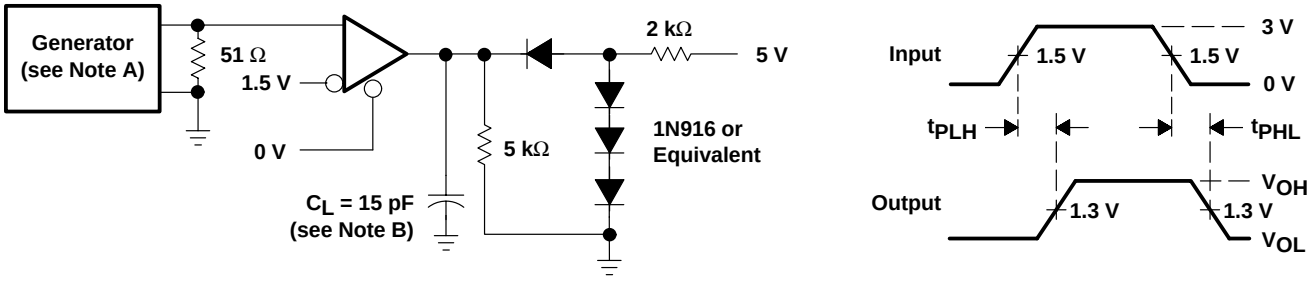
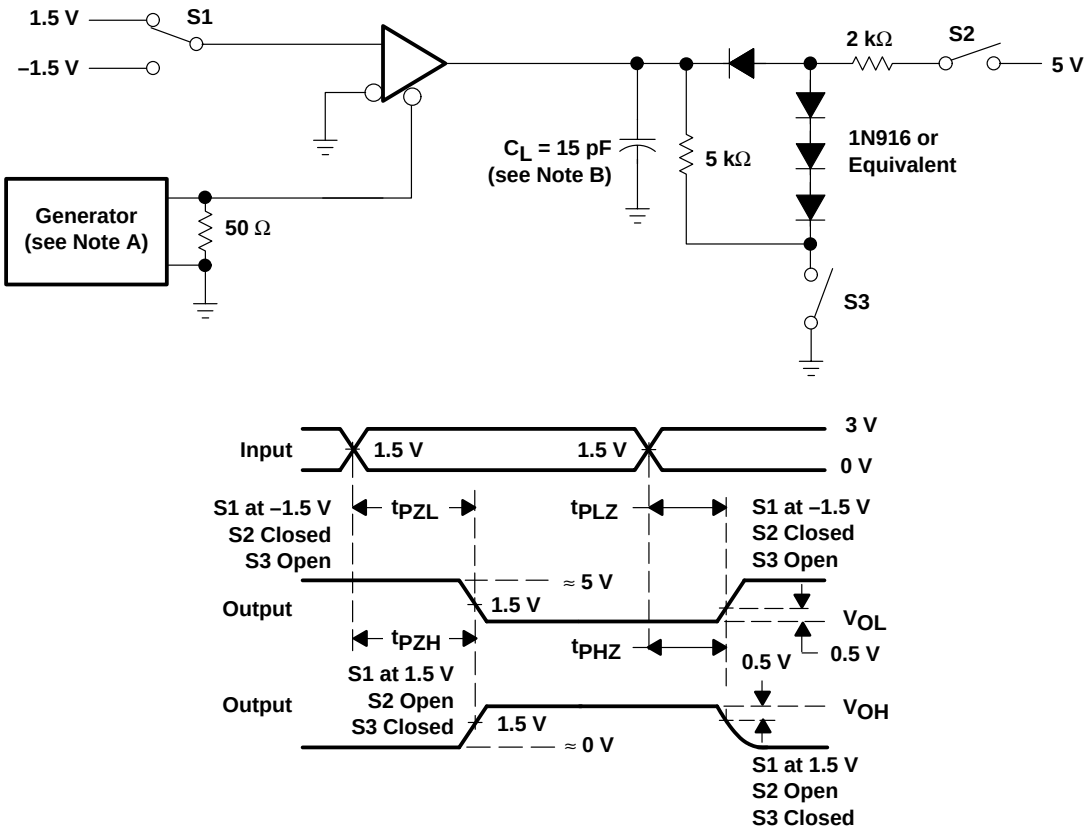


Figure 5. Receiver Propagation Delay Times



NOTES: A. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, Z_O = 50 Ω, t_r ≤ 10 ns, t_f ≤ 10 ns.
B. C_L includes probe and jig capacitance.

Figure 6. Receiver Enable/Disable Times

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